SKT 1200/18 E

Capsule Thyristor

Line Thyristor

SKT 1200/18 E

Features

- Hermetic metal case with ceramic insulator
- Capsule package for double sided cooling
- Shallow design with single sided cooling
- International standard case
- Off-state and reverse voltages up to 1800 V
- Amplifying gate

Typical Applications*

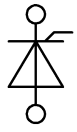
- DC motor control (e. g. for machine tools)
- Controlled rectifiers (e. g. for battery charging)
- AC controllers (e. g. for temperature control)
- Recommended snubber network e. g. for $V_{VRMS} \leq 400$ V: R = 33 Ω/32 W, C = 1 µF

Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Chip				
$I_{T(AV)}$	sinus 180°	T_c = 85 °C	1200	A
		T_c = 100 °C	840	A
I_{TSM}	10 ms	T_j = 25 °C	30000	A
		T_j = 125 °C	25500	A
i^2t	10 ms	T_j = 25 °C	4500000	A^2s
		T_j = 125 °C	3251250	A^2s
V_{RSM}			1800	V
V_{RRM}			1800	V
V_{DRM}			1800	V
$(di/dt)_{cr}$	T_j = 125 °C		125	A/µs
$(dv/dt)_{cr}$	T_j = 125 °C		1000	V/µs
T_j			-40 ... +125	°C
Module				
T_{stg}			-40 ... +130	°C

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
Chip						
V_T	T_j = 25 °C, I_T = 3600 A				1.65	V
$V_{T(TO)}$	T_j = 125 °C				0.95	V
r_T	T_j = 125 °C				0.18	mΩ
I_{DD};I_{RD}	T_j = 125 °C, $V_{DD} = V_{DRM}$; $V_{RD} = V_{RRM}$				160	mA
t_{gd}	T_j = 25 °C, I_G = 1 A, di_G/dt = 1 A/µs			1		µs
t_{gr}	$V_D = 0.67 * V_{DRM}$			2		µs
t_q	T_j = 125 °C		100		250	µs
I_H	T_j = 25 °C			250	500	mA
I_L	T_j = 25 °C, R_G = 33 Ω			500	2000	mA
V_{GT}	T_j = 25 °C, d.c.		3			V
I_{GT}	T_j = 25 °C, d.c.		250			mA
V_{GD}	T_j = 125 °C, d.c.				0.25	V
I_{GD}	T_j = 125 °C, d.c.				10	mA
$R_{th(j-c)}$	continuous DC	SSC				K/W
		DSC			0.021	K/W
$R_{th(j-c)}$	sin. 180°	SSC			0.054	K/W
		DSC			0.0225	K/W
$R_{th(j-c)}$	rec. 120°	SSC			0.06	K/W
		DSC			0.027	K/W
Module						
$R_{th(c-s)}$	SSC			0.01		K/W
	DSC			0.005		K/W
F			22		25	KN
a						m/s^2
w				480		g



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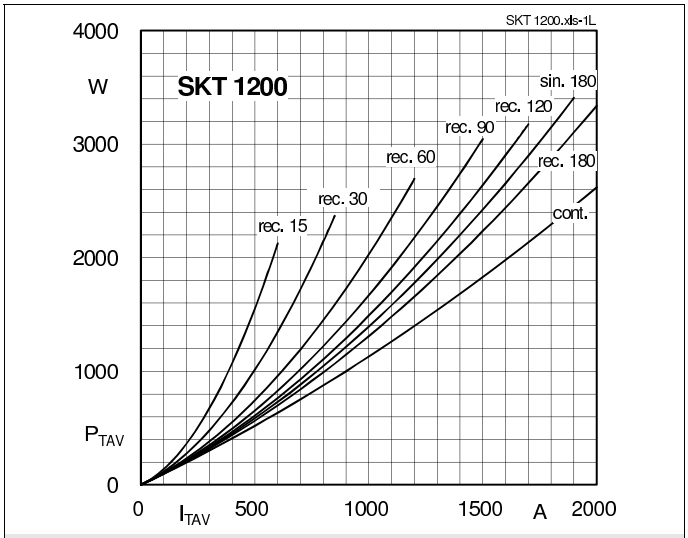

Fig. 1L: Power dissipation vs. on-state current

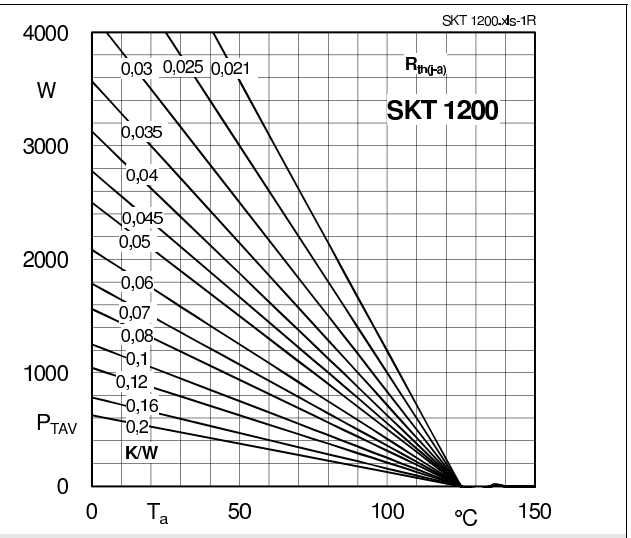

Fig. 1R: Power dissipation vs. ambient temperature

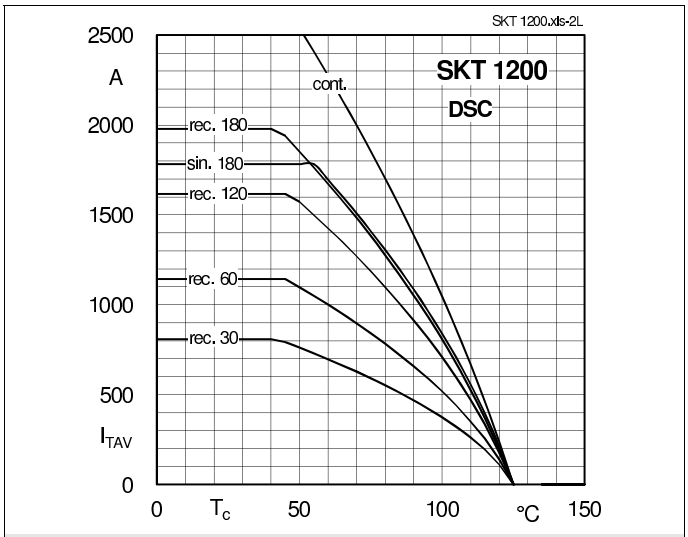

Fig. 2L: Rated on-state current vs. case temperature

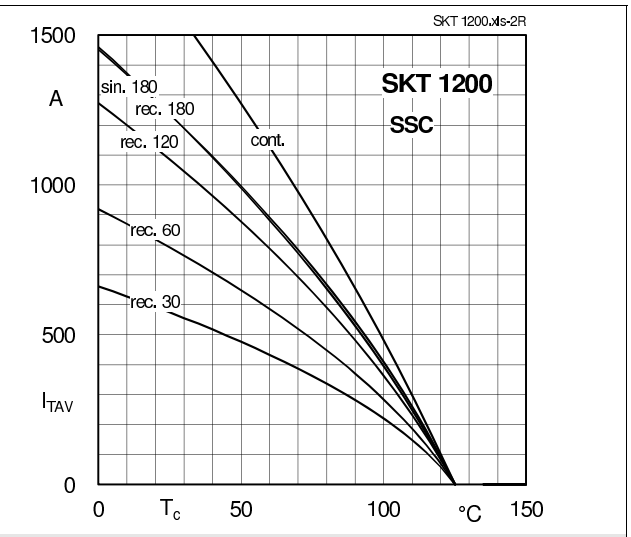

Fig. 2R: Rated on-state current vs. case temperature

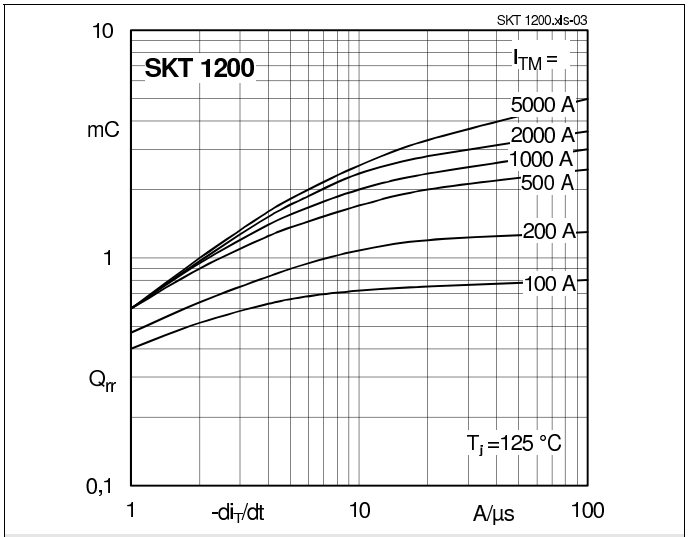

Fig. 3: Recovered charge vs. current decrease

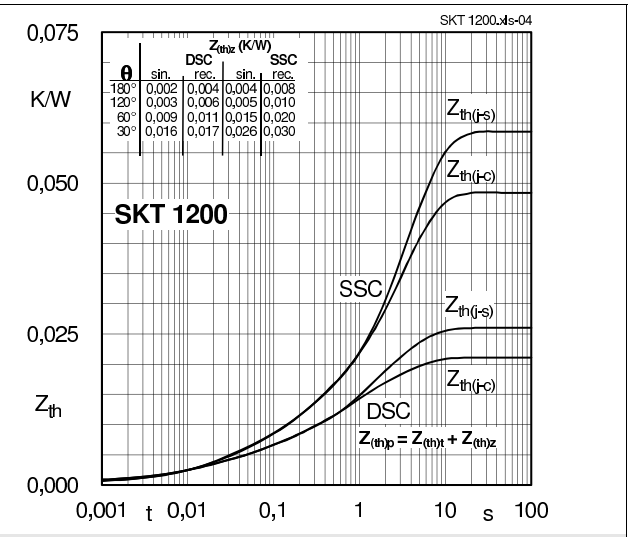

Fig. 4: Transient thermal impedance vs. time

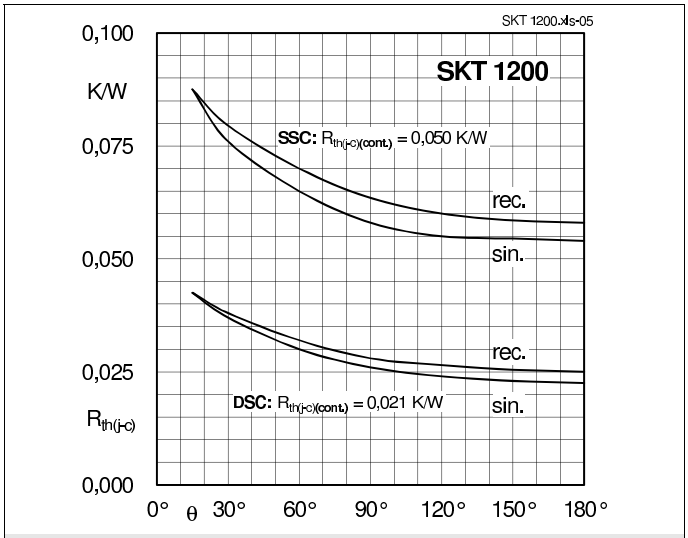

Fig. 5: Thermal resistance vs. conduction angle

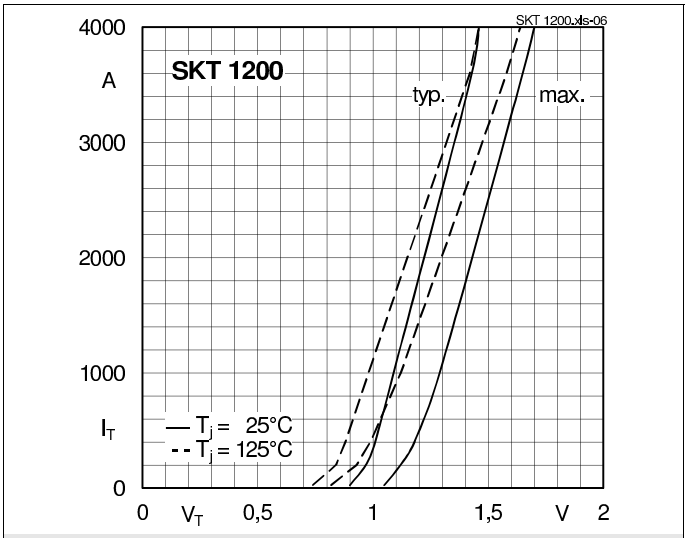

Fig. 6: On-state characteristics

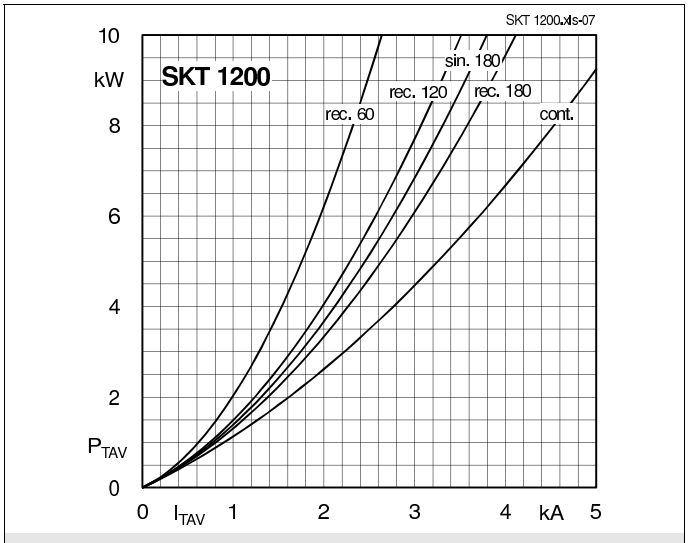

Fig. 7: Power dissipation vs. on-state current

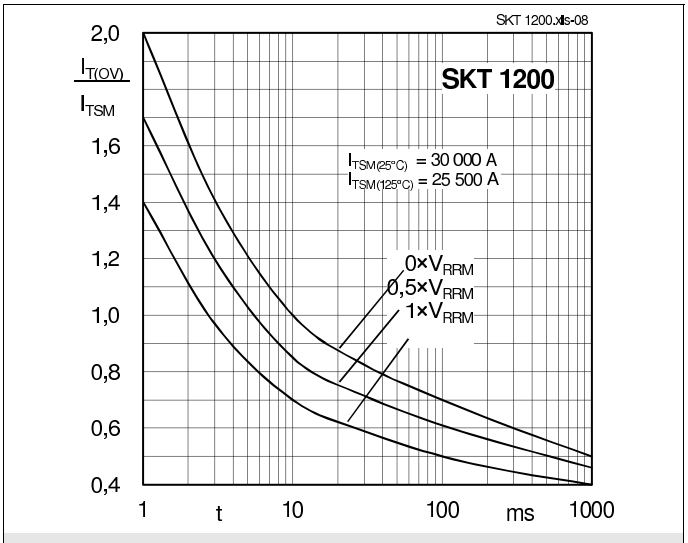

Fig. 8: Surge overload current vs. time

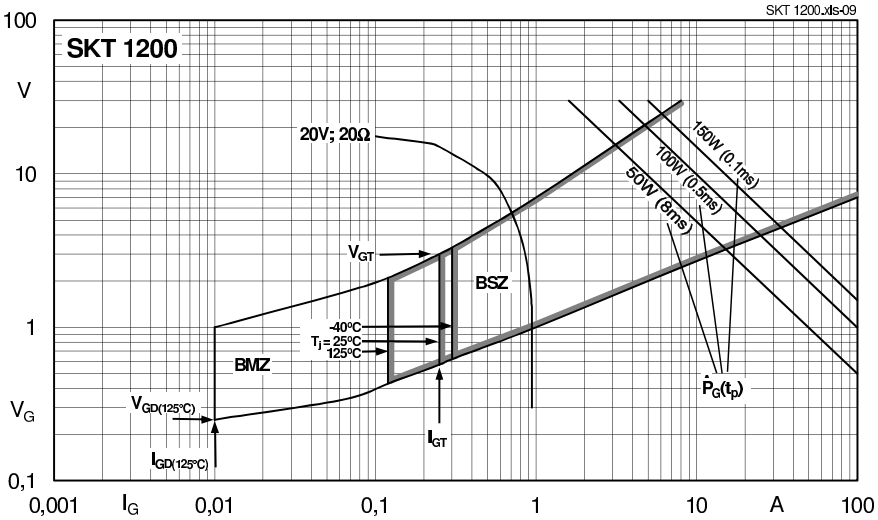

Fig. 9: Gate trigger characteristics

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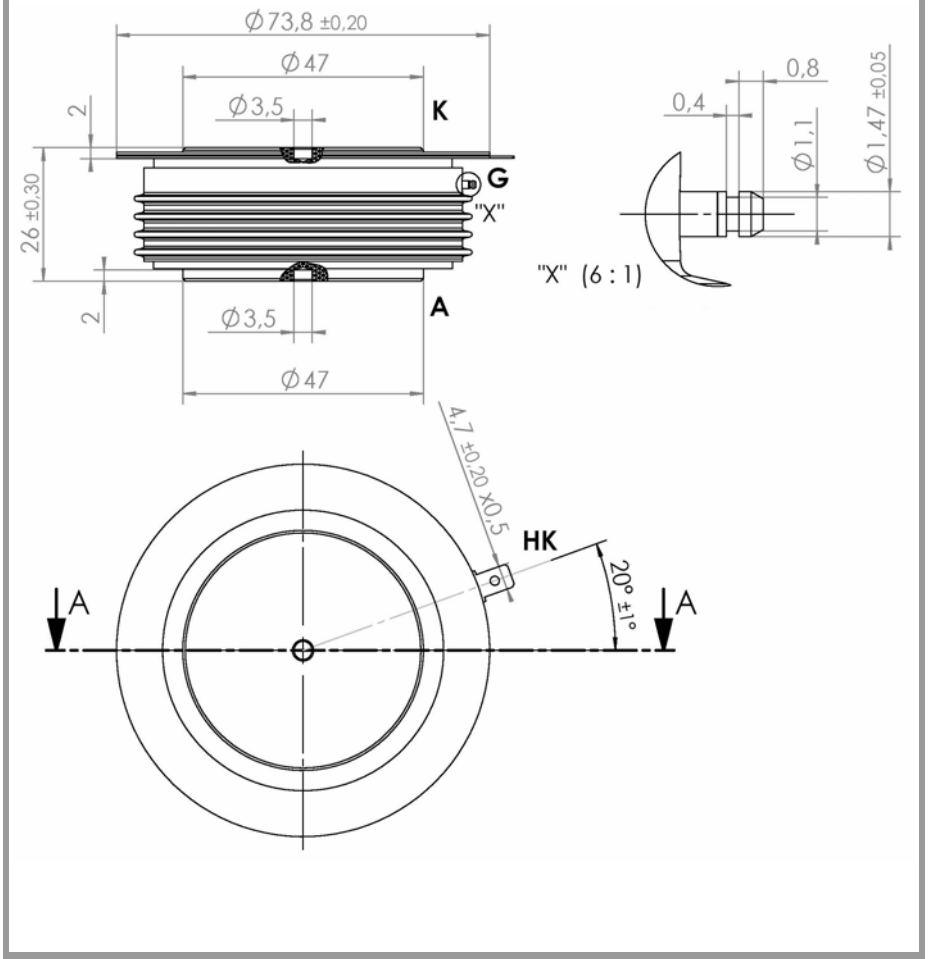

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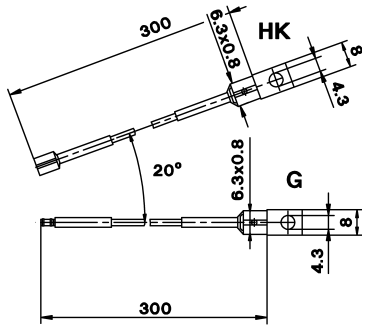

HK/Gate leads: ID-No.:33901270

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.